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**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/507,507  
Filing Date: September 13, 2004  
Applicant: Akio OZASA et al.  
Group Art Unit: 1791  
Examiner: Dimple N. Bodawala  
Title: METHOD AND MOLD FOR MANUFACTURING  
BIODEGRADABLE MOLDED ARTICLES  
Attorney Docket: 12480-000061/US

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Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
**Mail Stop AF**

July 22, 2010

**STATEMENT UNDER 37 C.F.R. § 1.133(b)**

Sir:

In response to the telephonic interview conducted on June 18, 2010 and the Interview Summary dated June 22, 2010, the following remarks are respectfully submitted in connection with the above-identified application.

**Interview Summary**

Applicants wish to thank the Examiner for the courtesies extended during the telephonic interview conducted on June 18, 2010.

Applicants have reviewed the Interview Summary and have found it to be substantially accurate in its description of the substance of the interview.

**CONCLUSION**

Should there be any outstanding matters that need to be resolved in the present application; the Examiner is respectfully requested to contact the undersigned at the telephone number of the undersigned below.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 08-0750 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

HARNESS, DICKY, & PIERCE, P.L.C.

By



Donald J. Daley, Reg. No. 34,313

DJD/EGH:vrj

P.O. Box 8910  
Reston, Virginia 20195  
(703) 668-8000